

	L #	Hits	Search Text	DBs
1	L1	168	174/262.ccls. and (dielectric same substrate)	USPAT; EPO; JPO; DERWEN T; USOCR
2	L2	38	1 and (copper adj layer)	USPAT; EPO; JPO; DERWEN T; USOCR
3	L3	11	2 and sacrificial	USPAT; EPO; JPO; DERWEN T; USOCR
4	L4	10	3 and ((through adj hole) or via)	USPAT; EPO; JPO; DERWEN T; USOCR
5	L5	1	4 and photolithographic	USPAT; EPO; JPO; DERWEN T; USOCR
6	L6	21	("3374129"   "3436819"   "3601523"   "3726002"   "4008300"   "4150421"   "4383363"   "4442966"   "4511757"   "4572764"   "4641425"   "4642160"   "4706165"   "4935584"   "5006673"   "5025555"   "5048166"   "5133120"   "5136471"   "5281151"   "5286926").PN.	USPAT
7	L7	46	5450290.URPN.	USPAT